

Taiwan Union Technology

TEST REPORT

| CLIENT: | IPC Validation Services 3000 Lakeside Drive Suite 105N Bannockburn, IL 60015 USA Attention: Mr. Randy Cherry +1-847-597-5606 |
|----------------|---|
| TEST ITEMS: | Peel Strength, Volume Resistivity, Surface Resistivity, Moisture Absorption, Dielectric Breakdown, Permittivity and Loss Tangent, Flexural Strength, Arc Resistance, Thermal Stress, Electric Strength, Vertical Flammability Test, Glass Transition Temperature, Decomposition Temperature, Z-Axis CTE (TMA), Time to Delamination (T260, T288, T300), Glass Transition Temperature (DMA), Dimensional Stability, Solderability, Chemical Resistance, Metal Surfaces Cleanability, Pressure Cooker Test. |
| SAMPLE: | Copper-Clad Laminate |
| TEST MATERIAL: | TU-883A |
| SPECIFICATION: | IPC-4101E WAM1/134 |
| TEST RESULTS: | The specimens were tested by the indicated test methods within this report. The actual detailed test results are enclosed. |

DATE OF REPORT: 16 August 2022



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SUMMARIZED TEST RESULTS:

| Test Item | Thin | Thick | |
|------------------------------|-------------|-------------|--|
| | | | |
| Peel Strength | Pass | Pass | |
| Volume Resistivity | Pass | Pass | |
| Surface Resistivity | Pass | Pass | |
| Moisture Absorption | | Pass | |
| Dielectric Breakdown | | Pass | |
| Permittivity | Pass | Pass | |
| Loss Tangent | Pass | Pass | |
| Flexural Strength | | Pass | |
| Arc Resistance | Pass | Pass | |
| Thermal Stress | Pass | Pass | |
| Electric Strength | Pass | | |
| Vertical Burning Test | Pass | Pass | |
| Glass Transition Temperature | | Pass | |
| Decomposition Temperature | | Pass | |
| Z-Axis CTE (TMA) | | Pass | |
| Time to Delamination | | Pass | |
| Dimensional Stability | Pass | Pass | |
| Solderability | | Pass | |
| Chemical Resistance | Report Only | Report Only | |
| Metal Surface Cleanability | | Report Only | |
| Pressure Cooker Test | | Report Only | |
| | | | |



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Peel Strength

Reference:

IPC-TM-650 Method 2.4.8 Peel Strength of Metal Clad Laminates IPC-TM-650 Method 3.4.8.3 Peel Strength of Metal Clad Laminates at Elevated Temperature IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 1 Peel Strength After Thermal Strength Thin

| Side A Cross-Wise and Length-Wise Average | 0.82 | |
|---|------------------|------|
| Side B Cross-Wise and Length-Wise Average | 0.85 | |
| Requirement | <u>></u> 0.70 | Pass |

Table 2 Peel Strength After Thermal Strength Thick

| Side A Cross-Wise and Length-Wise Average | 0.81 | |
|---|----------------|------|
| Side B Cross-Wise and Length-Wise Average | 0.82 | |
| Requirement | <u>></u> 70 | Pass |

Table 3 Peel Strength At Elevated Temperature Thin

| Side A Cross-Wise and Length-Wise Average | 0.74 | |
|---|------------------|------|
| Side B Cross-Wise and Length-Wise Average | 0.75 | |
| Requirement | <u>></u> 0.70 | Pass |

Table 4 Peel Strength At Elevated Temperature Thick

| Side A Cross-Wise and Length-Wise Average | 0.74 | |
|---|------------------|------|
| Side B Cross-Wise and Length-Wise Average | 0.73 | |
| Requirement | <u>></u> 0.70 | Pass |



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Table 5 Peel Strength After Process Solutions Thin

| Side A Cross-Wise and Length-Wise Average | 0.79 | |
|---|------------------|------|
| Side B Cross-Wise and Length-Wise Average | 0.78 | |
| Requirement | <u>></u> 0.70 | Pass |

Table 6 Peel Strength After Process Solutions Thick

| Side A Cross-Wise and Length-Wise Average | 0.79 | |
|---|------------------|------|
| Side B Cross-Wise and Length-Wise Average | 0.77 | |
| Requirement | <u>></u> 0.70 | Pass |

Table 7 Peel Strength As Received Low Profile Copper Thin

| Side A Cross-Wise and Length-Wise Average | 0.79 |
|---|-------------------|
| Side B Cross-Wise and Length-Wise Average | 0.78 |
| | No Requirement |

Table 8 Peel Strength As Received Low Profile Copper Thick

| Side A Cross-Wise and Length-Wise Average | 0.80 |
|---|-------------------|
| Side B Cross-Wise and Length-Wise Average | 0.79 |
| | No Requirement |



Taiwan Union Technology Volume & Surface Resistivity

Reference:

IPC-TM-650 Method 2.5.17.1 Volume and Surface Resistivity of Dielectric Materials IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 9 Volume and Surface Resistivity Humidity Conditioning Thin

| Volume Resistivity | Average of three specimens | 2.37 E+08 | |
|------------------------|----------------------------|-----------------------|------|
| Requirement C-96/35/90 | | <u>></u> 1.00 E+06 | Pass |
| | | | |
| Surface Resistivity | Average of three specimens | 4.77 E+08 | |
| Requirement C-96/35/90 | | <u>></u> 1.00 E+05 | Pass |

Table 10 Volume and Surface Resistivity At Elevated Temperature Thin

| Volume Resistivity | Average of three specimens | 3.25 E+07 | |
|---------------------|------------------------------|-----------------------|------|
| Requirement 125°C | | <u>≻</u> 1.00 E+06 | Pass |
| Surface Resistivity | Average of three specimens | 5.24 E+07 | |
| 2 | Average of three specificity | <u>></u> 1.00 E+05 | |
| Requirement 125°C | | | Pass |

Table 11 Volume and Surface Resistivity Humidity Conditioning Thick

| Volume Resistivity | Average of three specimens | 2.15 E+08 | |
|----------------------------|----------------------------|--------------------|------|
| Requirement after mois | ture | 1.00 E+05 | Pass |
| | | | |
| Surface Resistivity | Average of three specimens | 4.41 E+07 | |
| Requirement after moisture | | <u>≻</u> 1.00 E+06 | Pass |



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Table 12 Volume and Surface Resistivity At Elevated Temperature Thick

| Volume Resistivity Requirement 125°C | Average of three specimens | 1.61 E+07 ≥1.00 E+06 | Pass |
|---|----------------------------|-------------------------|------|
| Surface Resistivity | Average of three specimens | 5.58 E+07 | |
| Requirement 125°C | | <u>></u> 1.00 E+05 | Pass |



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Taiwan Union Technology Moisture Absorption

Reference:

IPC-TM-650 Method 2.6.2.1 Water Absorption of Metal Clad Plastic Laminates IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 13 Moisture Absorption Thick

| Moisture Absorption | Average of three specimens | 0.17 | |
|---------------------|----------------------------|-----------------|------|
| Requirement | | <u><</u> 0.2 | Pass |

Dielectric Breakdown

Reference:

IPC-TM-650 Method 2.5.6 Dielectric Breakdown IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 14 Dielectric Breakdown

| Dielectric Breakdown | Average of four specimens | 44+ | |
|----------------------|---------------------------|----------------|------|
| Requirement | | <u>></u> 40 | Pass |



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Permittivity and Loss Tangent

Reference:

IPC-TM-650 Method 2.5.5.9 Permittivity and Loss Tangent, Parallel Plate 1 MHz to 1.5 MHz IPC-TM-650 Method 2.5.5.15 Permittivity and Loss Tangent by SPDR 1 GHz to 20 GHz IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Boards

Results:

| Permittivity @ 1 MHz Requirement Thin | Average of three specimens | 3.6 <u>≤</u> 4.3 | Pass |
|---|----------------------------|----------------------------|------|
| Loss Tangent @ 1 MHz Requirement Thin | Average of three specimens | 0.003 <u>≤</u> 0.006 | Pass |
| Permittivity @ 1 MHz Requirement Thick | Average of three specimens | 3.70 <u>≤</u> 4.3 | Pass |
| Loss Tangent @ 1 MHz Requirement Thick | Average of three specimens | 0.004 <u>≤</u> 0.006 | Pass |
| Permittivity @ 1 GHz Requirement Thin | Average of three specimens | 3.70 <u>≤</u> 4.3 | Pass |
| Loss Tangent @ 1 GHz Requirement Thin | Average of three specimens | 0.003 <u>≤</u> 0.006 | Pass |
| Permittivity @ 1 GHz Requirement Thick | Average of three specimens | 3.90 <u>≤</u> 4.3 | Pass |
| Loss Tangent @ 1 GHz Requirement Thick | Average of three specimens | 0.003 <u><</u> 0.006 | Pass |

Table 15 Permittivity and Loss Tangent



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| Permittivity @ 10 GHz | Average of three specimens | 3.54 | Pass |
|-----------------------|----------------------------|-------------------|------|
| Requirement Thin | | < 4.2 | |
| Loss Tangent @ 10 GHz | Average of three specimens | 0.0039 | |
| Requirement Thin | | < 0.006 | Pass |
| Permittivity @ 10 GHz | Average of three specimens | 3.91 | |
| Requirement Thick | | <u><</u> 4.2 | Pass |
| Loss Tangent @ 10 GHz | Average of three specimens | 0.0041 | Pass |
| Requirement Thick | | <u><</u> 0.006 | |
| Permittivity @ 20 GHz | Average of three specimens | 3.50 | |
| Requirement Thin | | <u>≺</u> 4.2 | Pass |
| Loss Tangent @ 20 GHz | Average of three specimens | 0.0038 | |
| Requirement Thin | | <u><</u> 0.006 | Pass |
| Permittivity @ 20 GHz | Average of three specimens | 3.88 | |
| Requirement Thick | | <u>≺</u> 4.2 | Pass |
| Loss Tangent @ 20 GHz | Average of three specimens | 0.0045 | |
| Requirement Thick | | <u><</u> 0.006 | Pass |



Taiwan Union Technology Flexural Strength

Reference:

IPC-TM-650 Method 2.4.4 Flexural Strength of Laminates at Ambient Temperature IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer PrintedBoard

Results:

Table 16 Flexural Strength

| Flexural Strength Length Direction | Average of two specimens | 396 | |
|------------------------------------|--------------------------|-----------------|------|
| Requirement | | <u>></u> 345 | Pass |
| | | | |
| Flexural Strength Cross Direction | Average of two specimens | 353 | |
| Requirement | | <u>></u> 345 | Pass |

Arc Resistance

Reference:

IPC-TM-650 Method 2.5.1 Arc Resistance of Printed Wiring Material IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 17 Arc Resistance

| Arc Resistance Thin | Average of three specimens | 184 | |
|----------------------|----------------------------|----------------|------|
| Requirement | | <u>></u> 60 | Pass |
| | | | |
| Arc Resistance Thick | Average of three specimens | 189 | |
| Requirement | | <u>></u> 60 | Pass |



Taiwan Union Technology Thermal Stress

Reference:

IPC-TM-650 Method 2.4.13.1 Thermal Stress of Laminates IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 18 Thermal Stress

| Thermal Stress Thin Etched A Side | No obvious blister, delamination or damage | Pass |
|---------------------------------------|--|------|
| Thermal Stress Thin Etched B Side | No obvious blister, delamination or damage | Pass |
| | | |
| Thermal Stress Thick Etched A Side | No obvious blister, delamination or damage | Pass |
| Thermal Stress Thick Etched B Side | No obvious blister, delamination or damage | Pass |
| | | |
| Thermal Stress Thin Un-Etched A Side | No obvious blister, delamination or damage | Pass |
| Thermal Stress Thin Un-Etched B Side | No obvious blister, delamination or damage | Pass |
| | | |
| Thermal Stress Thick Un-Etched A Side | No obvious blister, delamination or damage | Pass |
| Thermal Stress Thick Un-Etched B Side | No obvious blister, delamination or damage | Pass |
| | | |

Electric Strength

Reference:

IPC-TM-650 Method 2.5.6.2 Electric Strength IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 19 Electric Strength

| Electric Strength Thin | Average of three specimens | 91 | |
|------------------------|----------------------------|----------------|------|
| Requirement | | <u>></u> 30 | Pass |



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Flammability Vertical Burning

Reference:

UL94 Section 8 50W (20mm) Vertical Burning Test; V-0, V-1, V-2 IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 20 Vertical Burning Test Thin

The specimens were tested by the methods given above. The flammability Classification Condition A of specimens is V-0 The flammability Classification Condition A of specimens is V-0 The specimens pass.

Table 21 Vertical Burning Test Thick

The specimens were tested by the methods given above. The flammability Classification Condition A of specimens is V-0 The flammability Classification Condition B of specimens is V-0 The specimens pass.

Glass Transition Temperature

Reference:

IPC-TM-650 Method 2.4.25 Glass Transition Temperature and Cure Factor by DSC IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer PrintedBoards

Results:

Table 22 Glass Transition Temperature

Glass Transition Temperature Requirement No Requirement / DMA only Test by DMA Only



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Reference:

IPC-TM-650 Method 2.4.24.6 Decomposition Temperature of Laminate Material Using TGA IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 23 Decomposition Temperature

| Glass Transition Temperature 5% Weight Loss | 441°C | |
|---|-----------------|------|
| Requirement | <u>></u> 400 | Pass |



Taiwan Union Technology Z-Axis CTE (TMA)

Reference:

IPC-TM-650 Method 2.4.24.6 Decomposition Temperature of Laminate Material Using TGA IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 24Z-Axis CTE (TMA)

| Z-Axis CTE Alpha 1 Average of two specimens Requirement | 28 <u><</u> 50 ₽ | ass |
|--|------------------------|------|
| Z-Axis CTE Alpha 2 Average of two | 183 | |
| specimens Requirement | <u>≺</u> 275 | Pass |
| Z-Axis CTE 50-260 Average of two | | |
| specimens | 2.8 | |
| Requirement | <u><</u> 2.9 | Pass |



Taiwan Union Technology Time to Delamination

Reference:

IPC-TM-650 Method 2.4.24.1 Time to Delamination (TMA Method) IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 25 Time to Delamination (TMA)

| Delamination T260 | Average of two specimens | > 60 | |
|-------------------|--------------------------|----------------|------|
| | Requirement | <u>></u> 60 | Pass |
| | | | |
| Delamination T288 | Average of two specimens | > 60 | |
| | Requirement | <u>></u> 60 | Pass |
| | | | |
| Delamination T300 | Average of two specimens | > 30 | |
| | Requirement | <u>></u> 30 | Pass |

Glass Transition Temperature (DMA)

Reference:

IPC-TM-650 Method 2.4.24.4 Glass Transition Temperature by DMA IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 26 Glass Transition Temperature (DMA)

| Glass Transition Temperature | 236°C | |
|------------------------------|-----------------|------|
| Requirement | <u>></u> 170 | Pass |



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Taiwan Union Technology Dimensional Stability

Reference:

IPC-TM-650 Method 2.4.39 Dimensional Stability, Glass Reinforced Thin LaminatesIPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 27Dimensional Stability Thin

| Dimensional Stability Bake | Average of three specimens | | |
|------------------------------|----------------------------|--------------|------|
| | Machine direction | -0.07 | |
| | Cross direction | -0.03 | |
| | Requirement | -0.3 to +0.3 | Pass |
| | | | |
| | | | |
| Dimensional Stability Stress | Average of three specimens | | |

| Machine direction | -0.04 | |
|-------------------|--------------|------|
| Cross direction | -0.05 | |
| Requirement | -0.3 to +0.3 | Pass |
| | | |

Table 28 Dimensional Stability Thick

| Dimensional Stability Bake | Average of three specimens | | |
|------------------------------|---|--------------------------------|------|
| | Machine direction | -0.01 | |
| | Cross direction | -0.03 | |
| | Requirement | -0.3 to +0.3 | Pass |
| Dimensional Stability Stress | Average of three specimens Machine direction Cross direction Requirement | -0.06 -0.02 -0.3 to +0.3 | Pass |
| | Requirement | -0.3 to +0.3 | Pass |



Taiwan Union Technology Solderability (Edge Dip Test)

Reference:

IPC-J-STD-003C; Method 4.2.1 Edge Dip Test IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 29 Solderability

| Solderability Thin | Sample surface exhibited good wetting | Pass |
|---------------------|---------------------------------------|------|
| Solderability Thick | Sample surface exhibited good wetting | Pass |

Chemical Resistance

Reference:

IPC-TM-650 Method 2.3.4.2 Chemical Resistance of Laminates, Prepreg and Coated Foil Products by Solvent Exposure. IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 30 Chemical Resistance

| Chemical Resistance Thin | Three specimens | | |
|--|--|-----------|------|
| Requirement | Appearance after bake | No change | Pass |
| Requirement | Appearance after solvent | No change | Pass |
| | | | |
| | | | |
| Chemical Resistance Thick | Three specimens | | |
| Chemical Resistance Thick Requirement | Three specimens Appearance after bake | No change | Pass |



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Metal Surface Cleanability

Reference:

IPC-TM-650 Method 2.3.1.1 Chemical Cleaning of Metal-Clad Laminate

IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 31 Metal Surface Cleanability

| Metal Surface Cleanability | Three specimens | |
|----------------------------|---|------|
| Requirement | The metal cladding on the test specimen shall | |
| | be cleaned to a uniform matte finish. | |
| | Deionized or distilled water poured on the | |
| | surface does not bead or form puddles. | Pass |

Pressure Cooker Test

Reference:

IPC-TM-650 Method 2.6.16 Pressure Vessel Method for Glass Epoxy Laminate Integrity IPC-4101E WAM1/134 Specification for Base Materials for Rigid and Multilayer Printed Board

Results:

Table 32Pressure Cooker Test

| Pressure Cooker Test | Five specimens | |
|----------------------|------------------------------------|------|
| Requirement | The samples shall have no measles, | |
| | blisters or surface erosion | Pass |



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CERTIFICATE OF CONFORMANCE

The TAWIAN UNION TECHNOLOGY CORPORATION (TUC) certifies that the test equipment used complies with the requirements of correlation criterion and that data contained in this report is accurate within the tolerance limitation of the equipment.

The report is invalid without the signature of the reviewer and the approver.

Reviewed by:

Approved by:

Neiting

Weiting Shen QA Engineer 16 August 2022

and

Money Wang QA Manager 16 August 2022

Douglas J. Sober

For IPC 16 August 2022